RoHS

COMPLIANT

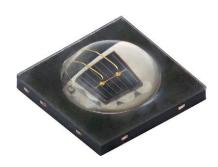
HALOGEN FREE

GREEN



Vishay Semiconductors

High Power Infrared Emitting Diode, 850 nm, Surface Emitter Technology



DESCRIPTION

As part of the <u>SurfLight</u>TM portfolio, the VSMY98575ADS is an infrared, 850 nm emitting diode based on surface emitter technology with high radiant power and high speed, molded in low thermal resistance SMD package with lens. A 42 mil chip provides outstanding radiant intensity and allows DC operation of the device up to 1 A. Superior ESD characteristics are ensured by an integrated Zener diode.

FEATURES

• Package type: surface-mount

- · Double stack technology
- Package form: power QFN
- Dimensions (L x W x H in mm): 3.85 x 3.85 x 1.51
- Peak wavelength: λ_D = 850 nm
- · Zener diode for ESD protection up to 2 kV
- High radiant power
- · High radiant intensity
- Angle of half intensity: $\varphi = \pm 75^{\circ}$
- Designed for high drive currents: up to 1 A (DC) and up to 5 A pulses
- Low thermal resistance: R_{thJP} = 9 K/W
- Floor life: 168 h, MSL 3, according to J-STD-020
- · Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



- Infrared illumination for CMOS cameras (CCTV, 3D gaming)
- Machine vision

| PRODUCT SUMMARY | | | | |
|-----------------|------------------------|---------|---------------------|---------------------|
| COMPONENT | I _e (mW/sr) | φ (deg) | λ _p (nm) | t _r (ns) |
| VSMY98575ADS | 320 | ± 75 | 850 | 14 |

Note

• Test conditions see table "Basic Characteristics"

| ORDERING INFORMATION | | | | | |
|----------------------|---------------|----------------------------|----------------------|--|--|
| ORDERING CODE | PACKAGING | REMARKS | PACKAGE FORM | | |
| VSMY98575ADS | Tape and reel | MOQ: 600 pcs, 600 pcs/reel | High power with lens | | |

Note

MOQ: minimum order quantity

| ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified) | | | | | |
|--|--------------------------------|-------------------|-------------|------|--|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT | |
| Reverse voltage | | V _R | 5 | V | |
| Forward current | | I _F | 1 | Α | |
| Peak forward current | $t_p/T = 0.5, t_p = 100 \mu s$ | I _{FM} | 2 | Α | |
| Surge forward current | t _p = 100 μs | I _{FSM} | 5 | Α | |
| Power dissipation | | P _V | 3.5 | W | |
| Junction temperature | | Tj | 115 | °C | |
| Operating temperature range | | T _{amb} | -40 to +85 | °C | |
| Storage temperature range | | T _{stg} | -55 to +100 | °C | |
| Soldering temperature | According to Fig. 7, J-STD-20 | T _{sd} | 260 | °C | |
| Thermal resistance junction / pin | JESD 51 | R _{thJP} | 9 | K/W | |



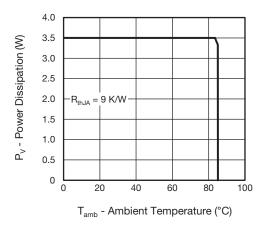


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

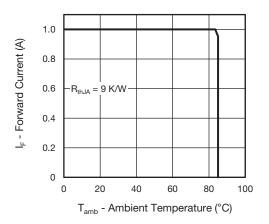


Fig. 2 - Forward Current Limit vs. Ambient Temperature

| BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified) | | | | | | |
|---|---|------------------|------|------|------|-------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Forward voltage | $I_F = 1 \text{ A}, t_p = 20 \text{ ms}$ | V _F | - | 3.1 | 3.5 | V |
| Temperature coefficient of V _F | I _F = 1 A | TK _{VF} | - | -3 | - | mV/K |
| Reverse current | V _R = 5 V | I _R | - | - | 10 | μΑ |
| Junction capacitance | $V_R = 0 \text{ V, f} = 1 \text{ MHz, E} = 0 \text{ mW/cm}^2$ | CJ | - | 130 | - | pF |
| Radiant intensity | $I_F = 1 \text{ A}, t_p = 20 \text{ ms}$ | l _e | 160 | 320 | - | mW/sr |
| Radiant power | $I_F = 1 \text{ A}, t_p = 20 \text{ ms}$ | фe | - | 1270 | - | mW |
| Temperature coefficient of ϕ_{e} | $I_F = 1 \text{ A}, t_p = 20 \text{ ms}$ | TH_{\phie} | - | -0.3 | - | %/K |
| Angle of half intensity | | φ | - | ± 75 | - | deg |
| Peak wavelength | I _F = 1 A | λ_{p} | 830 | 850 | 870 | nm |
| Spectral bandwidth | I _F = 1 A | Δλ | - | 35 | - | nm |
| Rise time | I _F = 1 A | t _r | - | 14 | - | ns |
| Fall time | I _F = 1 A | t _f | - | 17 | - | ns |

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

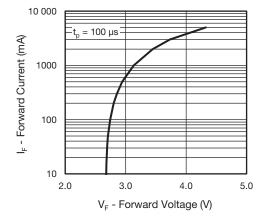


Fig. 3 - Forward Current vs. Forward Voltage

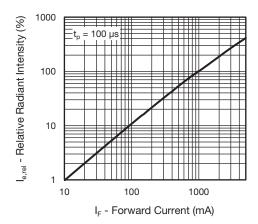
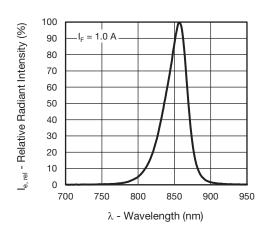
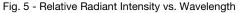


Fig. 4 - Relative Radiant Intensity vs. Forward Current





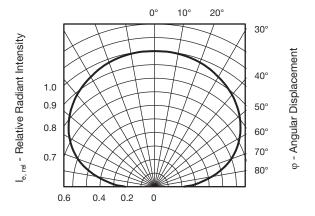
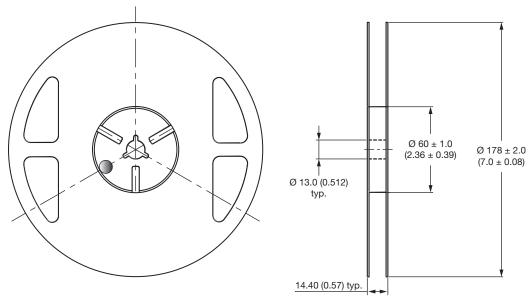


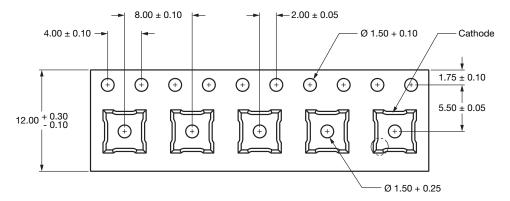
Fig. 6 - Relative Radiant Intensity vs. Angular Displacement

TAPING DIMENSIONS in millimeters

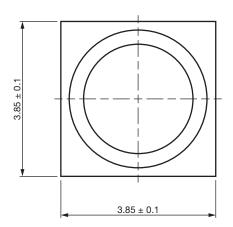


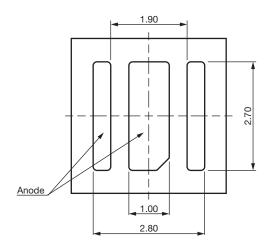
Notes

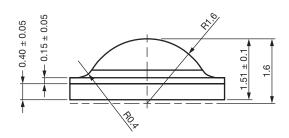
- Empty component pockets sealed with top cover tape
- 7 inch reel 600 pieces per reel
- The maximum number of consecutive missing lamps is two
- In accordance with ANSI / EIA 481-1-A-1994 specifications

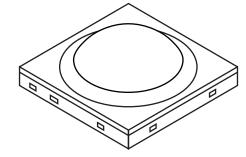


PACKAGE DIMENSIONS in millimeters





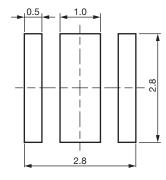




Notes

- Tolerance is \pm 0.10 mm (0.004") unless otherwise noted
- Specifications are subject to change without notice

SOLDER PAD PROPOSAL





SOLDER PROFILE

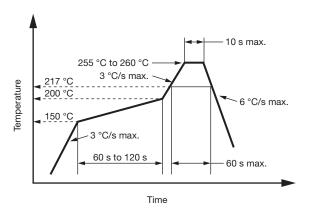


Fig. 7 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 3, according to J-STD-020B

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 $^{\circ}$ C (+ 5 $^{\circ}$ C), RH < 5 $^{\circ}$ M.



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Vishay

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